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Akhiezer mechanism limits coherent heat conduction in phononic crystals

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1	Akhiezer Mechanism Limits Coherent Heat Conduction in Phononic
2	Crystals
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13	Heat in phononic crystals (PnCs) are carried by phonons, which can behave
14	coherently (wave-like) or incoherently (particle-like) depending on the modes,
15	temperature, and length scales. By comparing the measured thermal conductivity of
16	PnCs with theories, recent works suggest that thermal conductivity of PnCs can be
17	explained by only considering surface and boundary scattering, which not only
18	backscatter phonons but also break their coherence. The logic here is that since average
19	phonon wavelength at room temperature is only a few nanometers, the roughness at the
20	surfaces and boundaries make the scattering diffusive (break the phase coherence of
21	phonons), and thus only very long wavelength (low frequency) phonons with negligible
22	contribute to total thermal conductivity remain coherent. Here, we theoretically show
23	that in a thin film and PnCs, the low-frequency coherent phonons could significantly
24	contribute to thermal conductivity when assuming three-phonon scattering model for
25	intrinsic scattering because of their extremely large density of states that resulted from
26	the low dimensional nature of those phonons. Yet, further analysis shows the
27	contribution of the low frequency coherent phonons are still negligible at a temperature
28	range from 130 K-300 K due to Akhiezer mechanism, which can properly answer the 1

question that why the thermal conductivity of PnCs can be explained by onlyconsidering scattering of incoherent phonons at these temperatures.

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I. INTRODUCTION

Phononic crystals (PnCs) with specifically designed periodic structures are meant to manipulate propagation of phonons using coherent effect (that is phase is preserved). In such a case, phonons follow the dispersion relation of PnCs, whose branches are folded with band gaps, which reduces group velocity, and hence results in reduction of thermal conductivity [1]. Benefit of manipulating thermal conductivity of PnCs using coherent effect is that it has smaller influence on electrons. Therefore, they are regarded as attractive candidate for enhancing figure of merit of thermoelectric materials.

The promising prospect of controlling phonons by using the coherent effect in 40 41 periodic structures has triggered many experimental measurements of the thermal conductivity for PnCs. Most popular class of PnCs is silicon thin films with periodic 42 holes as they can be fabricated by conventional microfabrication technique. However, 43 their thermal conductivity of PnC can be attributed to phonon coherent effect only for 44 45 temperatures below 10 K [2,3], and recent theoretical works have confirmed that thermal conductivity of PnC seen at room temperature in some of the early works can 46 be explained by only considering scattering of incoherent phonons (i.e. phonons lose 47 phase and follow the dispersion relation of bulk crystals instead of the dispersion 48 relation of PnCs), that is to say that coherent phonons have negligible contributions to 49 the thermal conductivity of PnCs at room temperature [4,5]. 50

A possible theoretical explanation for the negligible contribution of coherent phonons is that the coherent transport requires atomically smooth boundary surfaces, and absence of impurities and defects [6-9], which can only be realized in limited structures such as superlattices [10,11]. As results, in PnCs, coherence of thermal phonons, whose wavelengths are only a few nanometers at room temperature, is lost

when scattered by nanoscale roughness and disorders. Therefore, room temperature 56 coherent transport only occurs for long-wave-length or low frequency phonons (<200 57 GHz [3,8]) with large relaxation time, but their small density of states makes the 58 contribution to thermal conductivity negligible. The logic of the above explanation is 59 true for bulk crystals but fails in the case of usual PnCs that take forms of films because 60 these low frequency coherent phonons have extremely large density of states owing to 61 the low dimensional nature of the PnCs [12,13], which will lead to the result that even 62 very low frequency coherent phonons could significantly contribute to thermal 63 conductivity when only considering three-phonon scattering mechanism for evaluating 64 intrinsic phonon relaxation time (here, intrinsic relaxation time is referred as the 65 lifetime due to phonon-phonon interaction [14]), as will be discussed later. That is to 66 say thermal conductivity of PnC cannot be explained by a boundary scattering of 67 incoherent phonons if only considering three phonon scattering. Therefore, the reason 68 for the negligible contribution of coherent phonons remain unclear. 69

70 In fact, the large contribution of low frequency coherent phonons suggests that more detailed discussion should be given to their relaxation time. Indeed, for low frequency 71 phonons at room temperature, the consideration of only three-phonon scattering 72 mechanism is not sufficient. Experimental measurements and theoretical works have 73 74 shown that relaxation time of low frequency phonons (sound waves) is dominated by Akhiezer damping rather than three-phonon scattering mechanism (Landau-Rumer 75 theory) in a variety of bulk materials [14-19]. The mechanism of Akhiezer damping is 76 a coupling of strain of sound waves and thermal phonons: sound wave strain disturb the 77 local occupation of thermal phonons whose frequencies depend on strain, and the 78 thermal phonons then collide with one another, returning the system to local thermal 79 equilibrium as energy is removed from the sound waves [15]. Such mechanism should 80 also affect relaxation process of coherent phonons in PnCs, which have frequencies 81 82 within sub-terahertz range, and are basically sound waves. Since the original work of 83 Akhiezer, the mechanism of Akhiezer was found to be important for the absorption of sound waves, as well as for energy dissipation in mechanical nanoresonators [20,21], 84

85 however, few studies have noticed its importance in the field of heat conduction.

In this work, we show that Akhiezer mechanism plays an important role in heat conduction for low dimensional materials like PnCs. We theoretically illustrate that Akhiezer mechanism significantly reduces contribution of coherent phonons to thermal conductivity of PnCs at the temperature regime from 130 K-300 K to the extent that it becomes intrinsically small even when there is no roughness, thus, properly answered the question that why the thermal conductivity of PnC can be explained by only considering scattering of incoherent phonons.

⁹³ II. THEORY FOR THERMAL CONDUCTIVITY OF COHERENT ⁹⁴ AND INCOHERENT PHONONS

95 The total thermal conductivity κ_{Total} of thin film and PnCs includes contributions of 96 both coherent (κ_{coh}) and incoherent phonons (κ_{inc}), which is expresses as [22]:

97
$$\kappa_{Total}(\omega_s) = \kappa_{coh}(\omega_s) + \kappa_{inc}(\omega_s)$$
 (1)

98 where ω_s is the upper frequency bound of the coherent regime, in other words, the 99 switching frequency between the coherent and incoherent regimes.

100 We calculate the contribution from incoherent phonons (κ_{inc}) of thin film and PnCs 101 based on the kinetic theory, which is expressed as:

102
$$\kappa_{inc}(\omega_s) = \int_{\omega_s}^{\infty} C(\omega) D_{bulk}(\omega) v_{bulk}(\omega) l(\omega) d\omega$$
(2)

103 where ω is the frequency; $C(\omega)$, $D_{bulk}(\omega)$, $v_{bulk}(\omega)$ denote the frequency dependent heat 104 capacity, bulk density of states and group velocity, respectively. $l(\omega)$ is the effective 105 mean free path of incoherent phonons obtained by Mento Carlo ray tracing method [23].

Similarly, contribution of coherent phonons to thermal conductivity (κ_{coh}) of thin film and PnCs is calculated by:

108
$$\kappa_{coh}(\omega_s) = \int_0^{\omega_s} C(\omega) D(\omega) v_g(\omega)^2 \tau(\omega) d\omega$$
(3)

109 where $D(\omega)$, $v_g(\omega) = \frac{\partial \omega}{\partial q}$ and $\tau(\omega)$ denote the frequency dependent density of states, 110 group velocity, and relaxation time for coherent phonons in thin film and PnC, 111 respectively.

112 The parameters $C(\omega)$, $D(\omega)$ and $v_g(\omega)$ in Eq. (3) can be calculated from phonon 113 dispersions of thin film and PnCs, which is obtained by solving the continuum-based 114 elastic wave equation using finite element method (FEM) [13]:

115
$$\mu \nabla^2 u + (\mu + \lambda) \nabla (\nabla \cdot u) = -\rho \omega^2 u$$
(4)

116 where *u* is the displacement vector, $\rho = 2329$ kg m⁻³ is the mass density of silicon crystal, 117 $\lambda = 69.3$ and $\mu = 81.3$ GPa are the Láme parameters of silicon crystal.

As discussed in Section I, relaxation of coherent phonons is expected to take two forms: three-phonon scattering mechanism (Landau-Rumer theory) and Akhiezer damping. Relaxation time due to three-phonon scattering mechanism is approximated by Klemens model, which is widely used and validated [24,25]:

where *T* is the temperature, and *B* is a constant often quantified empirically.

124 It should be noted that Landau-Rumer theory is also based on the concept of three-125 phonon scattering, however, it only includes sound-phonon-phonon interactions. Here, 126 we use three-phonon scattering model instead as it also includes sound-sound-sound 127 and sound-sound-phonon interactions, which is a more accurate description. On the 128 other hand, the relaxation time of Akhiezer damping is modeled using the expression 129 derived by Maris [17]:

130
$$\tau_A^{-1} = \frac{c_v \tau}{\rho v^2} \cdot \frac{\omega^2 \tau_{ph}(\langle \gamma^2 \rangle - \langle \gamma \rangle^2)}{1 + \omega^2 \tau_{ph}^2}$$
(6)

131 where C_v is the specific heat capacity per volume, γ is Gununeizen parameter, v is

phonon phase velocity, and τ_{ph} is the averaged relaxation time of thermal phonons.

Here, we include the mechanisms of both three-phonon scattering and Akhiezer damping into phonon relaxation time τ by using Matthiessen's rule as [14,16]:

135
$$\tau^{-1} = \tau_K^{-1} + \tau_A^{-1}$$
 (7)

136 Equation (6) shows that phonon relaxation time first yields a quadratic frequency dependence for the lower frequencies, with a factor almost three orders of magnitude 137 smaller than the three-phonon scattering, and in the high-frequency limit of the 138 Akhiezer model (around tens of GHz), the lifetime is independent of frequency, and 139 becomes constant [14]. This and Eq. (7) indicate that the relaxation time of phonons 140 first follows Akhiezer model and then transits to three-phonon scattering when phonon 141 142 frequency becomes higher. The transition frequency between three-phonon scattering and Akhiezer's damping is expected to happen around several hundred GHz, which was 143 first experimentally observed by Hasson and Many [19]. The transition zone of the two 144 145 scenarios was observed by Maznev et al. at room temperature [14].

146 **III. CONHERENT HEAT CONDUCTION**

147

A. Structures, Dispersion Relation and Group velocity

We considered a 2D silicon thin film with periodic cylindrical holes, which is the 148 most frequently studied representative PnC [3] (Fig. 1(a)). The height t, width w, and 149 150 hole diameter d of the PnC are set to 150 nm, 100 nm, and 80 nm, respectively. A folded dispersion relation in the frequency range of 0-160 GHz (Fig. 1(b)) is obtained by 151 solving Eq. (4) with 2D periodic boundary conditions. It is shown that the folded 152 dispersion curves become flatter as frequency increases, which indicates reduction in 153 group velocity (Fig. 1(c)). Further, although the frequency-dependent profile of group 154 velocity is scattered, when smoothed by averaging the group velocities for each 155 frequency, the profile in the range between 80 and 160 GHz shows a clear power law 156 frequency dependence. An exponent of -1.41 is obtained by fitting a power law to the 157

data in this frequency range. The fitting curve was then extrapolated to obtain average 158 group velocity in higher frequency regimes. Note that the extrapolation is needed 159 because the computational load to calculate full dispersion relations of higher frequency 160 phonons would become too large. The validity of the extrapolation was confirmed by 161 calculating tens of branches of dispersion around given frequencies within 1THz, and 162 the average group velocities around given frequencies were confirmed to agree with the 163 fitting curve. With the same approach as for PnC, we also obtained group velocity of 164 thin film with the same thickness (150 nm), and only average group velocity is plotted 165 (Fig. 1(c)). It is shown that the average group velocity of thin film is larger than that of 166 the PnC because periodic structures in PnC cause larger bandgaps, which reduces group 167 velocity. 168

169

B. Temperature Dependent Phonon Relaxation Time

Firstly, to show the validity of the calculation, we obtained phonon relaxation time 170 171 of bulk silicon crystals from first principles-based lattice dynamic calculation, which agrees with experimental data at a temperature range of 130 K-300 K (Fig. 2(a)). The 172 maximum difference between our calculation and experimental data is 25%. It is clear 173 that, for a given temperature, phonon relaxation time deviates from the three-phonon 174 175 scattering scenario, and transit to the Akhiezer damping scenario when phonon frequency becomes GHz. As a result, relaxation time of low frequency phonons is 176 reduced by 3 orders. It should be noted that the transition between the two scenarios 177 has been investigated only at room temperature for Si and GaAs-AlAs superlattice [14]. 178 Here, in Fig. 2(a), by comparing experiment data with our calculation, we observed that 179 the transition is take place at ~200 GHz for 200 K-300 K, and ~100 GHz for 130 K. 180

Now that the calculation is validated, we obtained relaxation time of acoustic branches (<12 GHz) for PnCs, as plotted in Fig. 2 (b), taking the case of 300 K as an example. It is shown that the trend of the relaxation time for the longitudinal mode of PnCs agrees with that of bulk crystals, however, the magnitude is smaller due to the folding effect, which yields phonon bandgaps and reduces phase velocity *v*. Other

acoustic branches show similar characteristics. For optical phonons, instead of 186 replacing phase velocity v in Eq. (6) by group velocity v_g , as in the work of E. Chavez-187 Angel *et al.* [26], we approximated v by the average phase velocity of all acoustic 188 branches considering that optical branches are folded acoustic ones. One can observe 189 that phonon relaxation time transits to that of three-phonon scattering as frequency 190 increases, which indicates that three-phonon scattering mechanism dominant phonon 191 decay process for high frequency phonons. Similar relaxation time transition also 192 193 happens for the 2D thin film, the difference is that average relaxation time of thin film is larger than that of PnC due to a larger phase velocity v, which resulted from smaller 194 bandgaps in dispersions relations of thin film. 195

C. Influence of Akhiezer Damping on Thermal Conductivity of Coherent Phonons

Next, we discuss how much the transition from three-phonon scattering to Akhiezer 198 damping can affect thermal conductivity of both bulk crystals, thin films and PnCs. We 199 first verified that such transition has negligible effect on the total thermal conductivity 200 of bulk crystals when temperature is below 300 K. As for thin films and PnCs, here we 201 assume the switching frequency ω_s as 0.2 THz, i.e. the coherent regime is 0-0.2 THz, 202 203 and leave the discussion of frequency dependence on the coherent regime for later, as 204 it does not affect the discussions here. It should be noted that the coherent regime is not taken randomly, but matches with the case that the thin film and PnC have a 2-nm 205 surface roughness [3,8], which is the average value of the most frequently measured 206 roughness in experiment (1 nm-3 nm). The method for determining the coherent regime 207 by roughness is discussed in the Appendix. The κ_{inc} is obtained by Monte Carlo 208 raytracing calculation, in which boundary scattering of incoherent phonons is included. 209 In case of coherent phonons behaving as waves, the boundary effect is included as the 210 211 folded dispersion of coherent phonons (Fig. 1), which are formed when the phonons 212 are reflected without dephasing at the periodic boundaries.

A comparison of thermal conductivity of thin film and PnC with two different

relaxation time τ models (with and without Akhiezer) for 130 K and 300 K is shown in 214 Fig. 3. Firstly, we discuss the results when there is only three phonon scattering. In this 215 case, κ_{coh} of thin film within 0-0.2 THz is 5 Wm⁻¹K⁻¹ at 300 K and 17.8 Wm⁻¹K⁻¹ at 130 216 K, which contributes about 7.4% and 15.2% of κ_{Total} for 300 K and 130 K, respectively 217 (Fig. 3(a)). The proportion of κ_{coh} in κ_{Total} becomes even larger for PnCs due to larger 218 density of states, which will be shown in the later discussion. At 300 K, κ_{coh} of PnC is 219 9.5 Wm⁻¹K⁻¹, which contributes 53% of κ_{Total} for PnC. At lower temperature of 130 K, 220 $\kappa_{\rm coh}$ of PnC reaches 33.3 Wm⁻¹K⁻¹, and contributes to 81.1% of $\kappa_{\rm Total}$ for PnC. If this is 221 the case, the total thermal conductivity of PnCs cannot be explained by scattering of 222 incoherent phonons, which is not the actual situation of previous theoretical and 223 experimental results [3-5]. As discussed in Section I and III(B), for low frequency 224 phonons, only considering three phonon scattering is not enough, Akhiezer damping 225 should be considered as a key issue for relaxation process of these phonons, and it can 226 be included in phonon relation time using Eq. (5) and Eq. (6). For the case that Akhiezer 227 is considered, κ_{coh} of both thin film and PnC is smaller than 0.5 Wm⁻¹K⁻¹ for 300 K and 228 130 K, and the proportion of κ_{coh} in κ_{Total} is less than 1%, which indicates that κ_{coh} is 229 negligible in both thin film and PnC for 130 K-300 K (Fig. 3(b)), and that κ_{Total} is almost 230 dominant by the incoherent part κ_{inc} . The implication here is that, for low dimensional 231 materials like thin film and PnCs, it is important to take Akhiezer damping into account 232 to accurately evaluate relaxation time of low frequency phonons, otherwise, their 233 contributions to thermal conductivity can be hugely overestimated by only considering 234 three-phonon scattering. 235

236

D. Phonon Density of States

From Section III (C), we see that Akhiezer damping does not influence total thermal conductivity of bulk silicon crystal but has large influence on thermal conductivity of PnCs. The reason lies in density of states, $D(\omega)$ (Fig. 4). In bulk crystal, $D(\omega)$ is proportional to ω^2 , which indicates that $D(\omega)$ of low frequency phonons is very small. Therefore, even relaxation time of these phonons is overestimated by only considering the ω^{-2} -dependent three-phonon scattering, their contributions to the total thermal conductivity of bulk silicon crystal is still negligible, in other words, we do not need to
consider Akhiezer damping effect on the thermal conductivity of bulk crystal below
300 K.

However, in PnCs, $D(\omega)$ transits from 3D, 2D to 1D as frequency decreases due to 246 coherent effect, and accordingly, the frequency dependence of $D(\omega)$ changes from ω^{-2} , 247 ω^{-1} to ω^{0} . As a result, $D(\omega)$ of low frequency phonons in thin film and PnC is much 248 249 larger than $D(\omega)$ in bulk crystals, which leads to a significant overestimation of $\kappa_{\rm coh}$ in thin film and PnCs when only considering the ω^{-2} -dependent three-phonon scattering 250 for intrinsic relaxation time. We also noticed that, in the case that without Ahkiezer 251 damping, $\kappa_{\rm coh}$ for PnC is larger than $\kappa_{\rm coh}$ of thin film (Fig. 3(a)), even phonon group 252 velocity is larger for thin film (Fig. 1). This is because $D(\omega)$ of acoustic phonon (< 12) 253 GHz) in PnCs is four times larger than $D(\omega)$ of acoustic phonon in thin film, which 254 would lead to severer overestimation κ_{coh} for PnC. 255

The conclusion for Section III is that, although the existence of a 2-nm surface 256 roughness makes the coherent regimes very small (0-0.2 THz), density of states of the 257 low frequency coherent phonons is much larger than that of bulk silicon crystals, 258 therefore, these phonons have large potential to contribute to thermal conductivity when 259 260 only three phonon scattering is considered. However, when Akhiezer mechanism is involved, relaxation time of these phonons is hugely reduced, as a result, the proportion 261 of κ_{coh} in κ_{Total} for both thin film and PnC is negligible (<1%), that is why the total 262 thermal conductivity of thin film and PnC, κ_{Total} can be explained by only considering 263 the contributions of incoherent phonons κ_{inc} . 264

Current result is consistent with the recent experimental and theorertical works on thin film PnCs [3][4][5]. They have successfully reproduced the experimental results with Monte Carlo calculations by ignoring the contribution of sub-THz phonon to thermal conductivity. The fact the calculation could reproduce the experiments means that the Akhiezer damping has suppressed the phonon relaxation time, and that the works are consistent with our work. Although the actual geometry of our PnC and these works are different, the above discussion on the dimension and contribution of sub-THz
phonon contribution should be applicable to PnC with thickness and holes on the order
of 100 nm.

IV. SWITCHING-FREQUENCY DEPENDENT CONHERENT AND INCONHERENT HEAT CONDUCTION

So far, our discussion has been based on the assumption that the roughness of the 276 thin film and PnC is 2 nm, and the switching frequency ω_s is ω_0 (=0.2 THz). However, 277 the ω_s can change when roughness on the surface is modified. Therefore, in what 278 279 follows, we consider ω_s as a variable to investigate contributions of coherent phonons 280 to thermal conductivity. Note that this also helps gain understanding of the case with no roughness, which is the theoretical upper limit of contribution of coherent phonons. 281 Nevertheless, we can determine the maximum value of ω_s using the criterion that MPF 282 283 of bulk phonons should be at least larger than several periods of periodic structures in PnCs (here, it is 100 nm). The reason is that coherent length should be smaller than 284 MFP bulk phonons, and MFP are required to be sufficient long such that they can cross 285 286 several periodicities, thereby creating many secondary waves to achieve interference effect, which results in the folded dispersion relation of PnCs [6]. The minimum number 287 288 of periodicity is two (that is phonon passes though the PnC and then be reflected back), which gives the upper bound of ω_{s} . 289

If $\omega_s < \omega_0$, κ_{coh} within 0- ω_s can be directly calculated by Eq. (3) with their full 290 dispersion relations, whereas if $\omega_s > \omega_0$, contributions of coherent phonons from ω_0 to 291 $\omega_{\rm s}$ is estimated by the averaging method due to a lack of information in full dispersion 292 relation. In the averaging method, we approximate the phonon group velocity and 293 density of states in Eq. (1) with the averaged group velocity obtained by the fitting 294 295 curve (Fig. 1(c)), and bulk phonon density of states (Fig. 4), respectively. The latter approximation is based on the observation that density of states of PnCs and bulk crystal 296 are roughly the same for frequencies above ω_0 (Fig. 4). Then, the switching-frequency 297

298 dependent $\kappa_{coh}(\omega_s)$ of PnCs or thinfilm can be expressed as:

299
$$\kappa_{coh}(\omega_s) = \kappa_0 + \int_{\omega_0}^{\omega_s} C(\omega) D_{bulk}(\omega) v_{av}(\omega)^2 \tau(\omega) d\omega$$
(8)

where κ_0 is the contribution of coherent phonons with frequencies between 0 and ω_0 , and the second term represents contribution of coherent phonons with frequencies between ω_0 and ω_s , where $v_{av}(\omega)$ is the averaged group velocity and $D_{bulk}(\omega)$ is the bulk phonon density of states.

For thin film and PnC at 300 K (Fig. 5(a) and Fig. 5(c)), the maximum coherent 304 regime is determined as 0-3.0 THz. We found that κ_{coh} of both thin film and PnC are 305 306 negligible when compared to κ_{inc} even ω_s reaches its maximum (3 THz). The results indicate that κ_{coh} contributes a very small proportion of κ_{Total} for both thin film and at 307 300 K, even there is no roughness effect. This is because of two reasons: one is that 308 Akhiezer damping significantly reduces relaxation time of phonons in the Akhiezer 309 310 regime (<0.2 THz for 300 K, Fig. 3(b)), and the other is that the group velocity of phonons in three-phonon-scattering regime (0.2 THz-3.0 THz, Fig. 3(b)) is small due 311 to phonon bandgaps that are caused by the folding effect. As a result, contributions of 312 phonons within the whole coherent regime are limited. 313

As temperature decreases to 130 K (Fig. 5(b) and Fig. 5(d)), the maximum value of 314 $\omega_{\rm s}$ increased to 4 THz, and Akhiezer damping is weakened due to a reduction in thermal 315 phonons population. Therefore, relaxation time of coherent phonons increases (Fig. 2), 316 however, Ahkiezer damping still has strong influence on $\kappa_{\rm coh}$ of thin film and PnC. For 317 the PnC at 130 K, the maximum value of $\kappa_{\rm coh}$ is only 0.1 Wm⁻¹K⁻¹. In thin film, the 318 value of $\kappa_{\rm coh}$ is larger when comparing with $\kappa_{\rm coh}$ for PnC, and can contribute to 5.8 Wm⁻ 319 1 K⁻¹ when ω_{s} reaches to its maximum (4 THz). This is because group velocity of three-320 phonon scattering regime (0.1 THz -4 THz for 130 K) is larger than that of PnC (Fig. 321 1). However, the proportion of κ_{coh} in κ_{Total} is still small (<8%). We also noticed that for 322 both thin film and PnC, sub-THz phonons contributes to the most part of κ_{coh} , and 323 above-THz coherent phonons does not contribute much to κ_{coh} due to their small group 324

velocity and relaxation time (Fig. 1(c) and Fig. 2).

Taking the most extremely case (no roughness) as an example, a comparison of 326 thermal conductivity of thin film and PnC with two different relaxation time τ models 327 at 130 K and 300 K is shown in Fig. 6. The discussion here is similar with Section 328 III(C). The coherent part, κ_{coh} can contribute a large part of κ_{Total} when without 329 considering Akhiezer damping. In thin film, κ_{coh} can contribute about 11.2% and 28% 330 331 of κ_{Total} for 300 K and 130 K, respectively. For PnC, contributions of κ_{coh} can even reach to 56% at 300 K and 85% of κ_{Total} . However, Akhiezer damping can reduced the 332 proportion to less than 2% for PnC at both 300 K and 130 K, and for thin film, the 333 proportion is less than 2% at 300 K and around 8% at 130 K. The value of the 334 proportions here is a litter larger than that in Section III(C), however, it is still small. 335 Therefore, we can conclude that the coherent phonons contribution κ_{coh} to the total 336 thermal conductivity κ_{Total} for both thin film and PnC is very small even there is no 337 roughness, or the κ_{Total} for both thin film and PnC can be explained by the contributions 338 339 of incoherent phonons.

Finally, it should be noted that currently our calculation here cannot deal with the 340 cases for temperatures that below 130 K. The reason is that Ahkiezer mechanism, as 341 342 original developed, only valid at high temperatures, however, up to date, the exact valid temperature regime is not known. We can extend our calculation to 130 K because the 343 experimental measurements match with theoretical calculations (Fig. 2). More 344 experimental measurements are still need below 130 K. On the other hand, the equation 345 for Ahkiezer damping (Eq. (6)) includes average phonon relation time of bulk silicon 346 crystal (τ_{ph}), which is often obtained by single phonon relaxation time approximation. 347 However, the single phonon relaxation time approximation for the Boltzmann equation 348 may not valid at lower temperatures. We hope that lower temperature measurements 349 350 and deeper theoretical analysis for phonon relaxation time in both bulk and 351 nanostructured materials will become available soon.

V. CONCLUSIONS

In conclusion, we show that average group velocity of high frequency coherent 354 phonons in thin film and PnC can be approximated by the exponential function $\omega^{-\beta}$ 355 $(\beta=0.66 \text{ and } 1.41 \text{ for our thin film and PnC samples, respectively})$, which indicates that 356 high frequency phonons has smaller group velocities, and thus contribute less to thermal 357 conductivity. Then, we show that low frequency coherent phonons in low dimension 358 materials like PnCs have extremely large density of states due to the low dimension 359 nature, which could significantly contribute to thermal conductivity when only 360 considering three phonon scattering. However, by comparing experiment data with our 361 calculation, we show that Akhiezer damping is dominant and should be considered 362 when dealing with relation time of low frequency phonons (<200 GHz for 200 K-300 363 K, and <100 GHz for 130 K). Because of Akhiezer damping, coherent phonons 364 contribution is reduced to the extent that their contribution to total thermal conductivity 365 of thin film and PnC at 130 K-300 K becomes very small (<8%), even there is no surface 366 367 roughness, that is why the total thermal conductivity of thin film and PnC can be explained by only considering the incoherent phonons contributions. 368

369

370 APPENDIX

In this section, we evaluate switching frequency ω_s as a function of roughness according to the work of M. R. Wagner *et al* [8]:

373
$$\omega_s = \frac{2\pi V_s}{R} \sqrt{\frac{-\ln(P)}{16\pi^3}}$$
(9)

where *R* is the roughness size (including surface roughness, hole wall roughness, lattice site displacement, disorder etc.); *P* is the specularity, here we use *P*=0.3 to define the boundary of coherent and incoherent regimes, i.e. the ω_s ; *V*_s is the longitudinal sound velocity as 8433 m/s [8].

- 378 Switching frequency as a function of roughness size R is shown in Fig. 7, from which
- we can obtain 0.2 THz for ω_s when R=2 nm. In the works of M. R. Wagner *et al*, P=0.5,
- here we use 0.3 just for a more conservative estimation.
- 381

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433 Figures



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Fig. 1 (a) Schematic of two-dimensional silicon phononic crystal (PnC). *t*=150 nm, *w*=100 nm and *d*=80 nm denotes the height, width, and hole diameter of the PnC,
respectively. (b) phonon dispersion relation of PnC along G-X. (c) frequency-dependent
group velocity of PnCs and thin film phonons.



Fig. 2 (a) Frequency and temperature dependent phonon relaxation time for bulk silicon 441 crystals. The dashed lines are calculated results for longitudinal modes (LA) at different 442 temperatures. Experimental data are measured results for LA modes and are taken from 443 the references [15,27-29] (b) Frequency-dependent relaxation time of thin film and 444 PnCs at 300 K, and a comparison with bulk phonon relaxation time for LA modes and 445 modes in Full Brillion zone (FB). The boundary of Akhiezer and 3-phonon scattering 446 regimes at 300 K is around 200 GHz. Note that "3-phonon scattering+Akhiezer" in Fig. 447 2 means the relaxation time calculated using Eq. (7) 448 449



Fig. 3 A comparison of thermal conductivity of thin film and PnC with two different relaxation time τ models at 130 K and 300 K for a 2-nm roughness. (a) τ model: only three-phonon scattering; (b) τ model: three-phonon scattering and Akhiezer damping. Coherent regime is determined as 0-0.2 THz for 300 K and 130 K when there is a 2-nm roughness.



Fig. 4 Frequency-dependent density of states $D(\omega)$ of thin film and PnCs, and a comparison with density of states of bulk silicon crystals



Fig. 5 Contributions of coherent and incoherent phonons to total thermal conductivity
of thin film and PnCs as a function of switching frequency at 300 K and 130 K. The
maximum coherent regime is determined as 0-3 THz at 300 K, and 0-4 THz at 130 K.



Fig. 6 A comparison of thermal conductivity of thin film and PnC with two different relaxation time τ models at 130 K and 300 K for the most idea case (no roughness). (a) τ model: only three-phonon scattering; (b) τ model: three-phonon scattering and Akhiezer damping. Coherent regime is respectively determined as 0-3 THz and 0-4 THz for 300 K and 130 K when there is no roughness.



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Fig. 7 Switching frequency as a function of roughness size R (surface roughness, hole wall roughness, lattice site displacement, hole disorder etc.) for selected specularity parameters P=0.3.